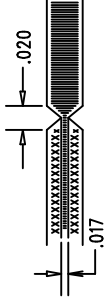


 LAYER 1 (COMPONENT SIDE)
 LAYER 2 (SOLDER SIDE)


NOTES : Unless Otherwise Specified

PCBS ARE TO BE RoHS COMPLIANT

1. MATERIAL : FR4 OR EQUIVALENT EPOXY
2 OZ OUTER COPPER CLAD
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
GOLD IMMERSION BOTH SIDES.
SOLDER MASK OVER BARE COPPER (SMOBC)
3. SOLDER MASK : BOTH SIDES USING GREEN LPI OR EQUIVALENT
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
5. DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE,
BUT YOU MAY MODIFY PAD SIZE TO MEET END FINISH
6. SCORING FOR PANELIZED PCB:(PRODUCTION RUN ONLY)



FAB DRAWING

APPROVALS					1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900	
DRAWN	INIT	DATE				
CHECK						
DESIGN	Antoninok	07/08/08	TITLE: LT8415EDDB			
ENGR	Jesus R	07/08/08	ULTRALOW POWER BOOST CONVERTER WITH DUAL HALF BRIDGE SWITCHES			
			SIZE	DEMO	DC1449A	REV. 2
SCALE = NONE						SHT 1 of 1